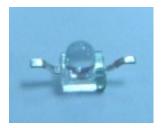


#### **DATASHEET**

# 1.9mm Round Subminiature "Z-Bend" Lead Infrared LED IR91-21C/TR10



#### **Features**

- Small double-end package
- High reliability
- Low forward voltage
- · Good spectral matching to Si photodetector
- Pb free
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH

#### **Descriptions**

- IR91-21C/TR10(TYM) is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens
- The device is spectrally matched with silicon photodiode and phototransistor

#### **Applications**

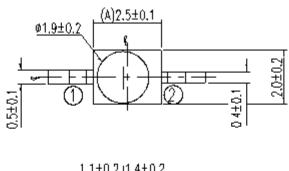
- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

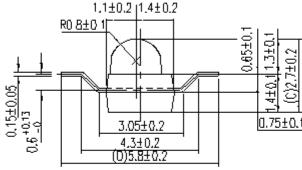
#### **Device Selection Guide**

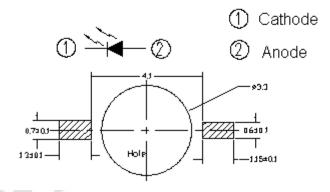
Part Category	Chip Material	Lens Color	
IR	GaAlAs	Water Clear	

# **EVERLIGHT**

# **Package Dimensions**







Notes: 1.All dimensions are in millimeters.

- 2. Tolerances unless dimensions ±0.1 mm.
- 3. Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.



Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Units
Continuous Forward Current	I <sub>F</sub>	65	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>opr</sub>	-25 ~ +85	
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	
Soldering Temperature*1	T <sub>sol</sub>	260	
Power Dissipation at (or below) 25 Free Air Temperature	$P_d$	130	mW

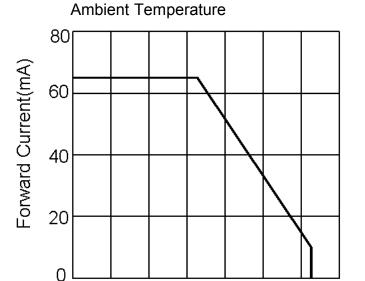
Notes: \*1: Soldering time 5 second

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Radiant Intensity	l <sub>e</sub>	I <sub>F</sub> =20mA	3.0	5.0		mW/sr
Peak Wavelength	$\lambda_{p}$		-	940		nm
Spectral Bandwidth	Δλ			50		nm
Forward Voltage	V <sub>F</sub>			1.2	1.5	V
View Angle	2θ1/2			25		Deg
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA
Rise Time	t <sub>r</sub>	L =100mA		507		
Fall Time	t <sub>f</sub>	I <sub>F</sub> =100mA		517		ns

# **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.



20

Ambient Temperature(°C)

40

60

80 100

Fig.2 Spectral Distribution

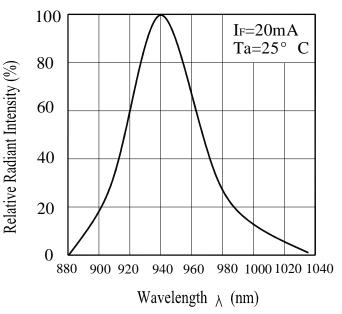
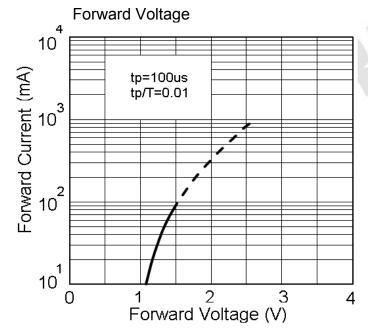


Fig.3 Forward Current vs.

-20

0

-40



上式發行 Approved

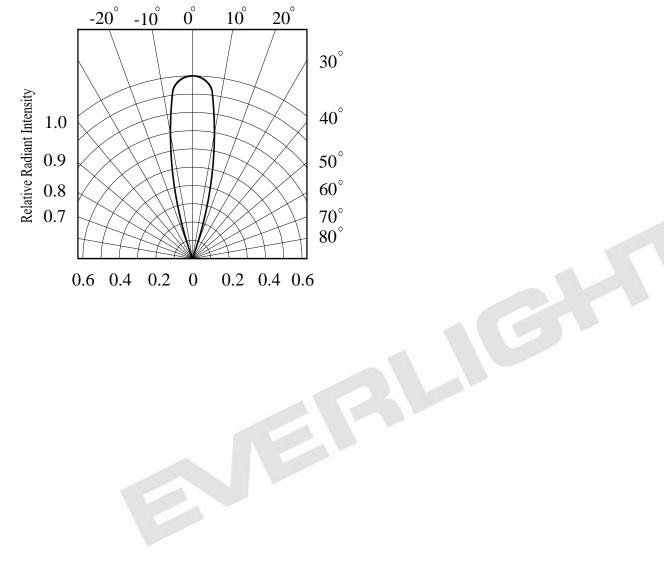
LifecyclePhase:



# **Typical Electro-Optical Characteristics Curves**

Fig.4 Relative Radiant Intensity vs.

**Angular Displacement** 



#### **Precautions For Use**

#### 1. Over-current-proof

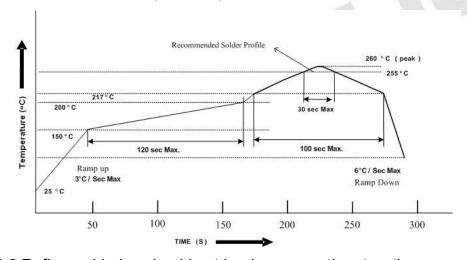
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 10 ~30 and 90%RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
  - 96 hours at 60°C ± 5°C and < 5 % RH (reeled/tubed/loose units)

### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.

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3.4 After soldering, do not warp the circuit board.

LifecyclePhase:

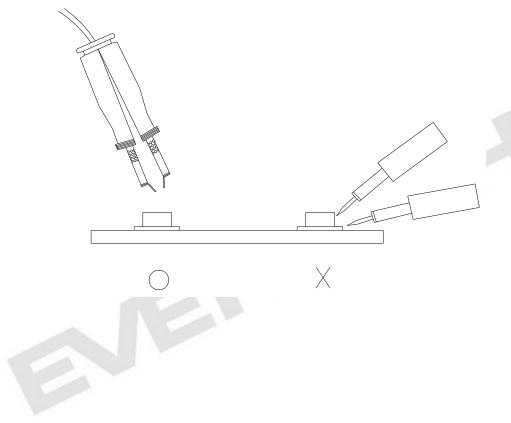
IR91-21C/TR10

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

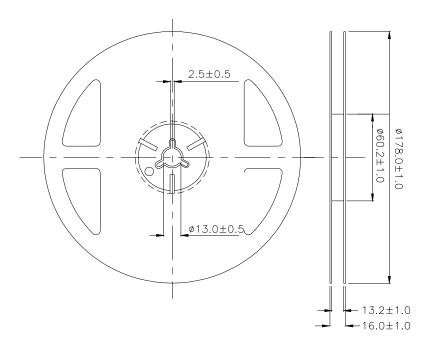


LifecyclePhase:

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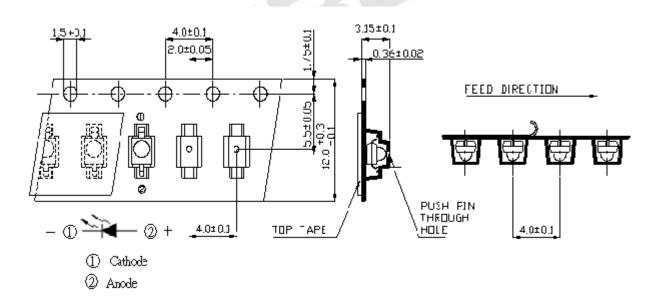


## **Package Dimensions**



Note: The tolerances unless mentioned are ±0.1mm, Unit: mm.

# Carrier Tape Dimensions:(Quantity: 1000pcs/reel)

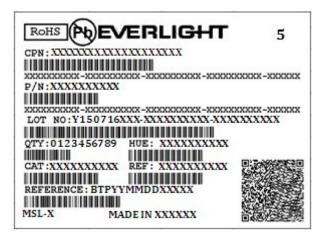


**Note:** The tolerances unless mentioned are ±0.1mm, Unit: mm.

LifecyclePhase:



## **Label Form Specification**



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

#### **Notes**

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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# 单击下面可查看定价,库存,交付和生命周期等信息

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